ABSOLUTE MAXIMUM RATINGS

DC, USB to GND0.3V to +16V	O
BAT, CT, CHG, EN, FLT, SETI,	Ju
POK, THM, USEL to GND0.3V to +6.0V	Ste
Continuous Power Dissipation ($T_A = +70$ °C)	Le
14-Pin TDFN 3mm x 3mm Multilayer PCB	
(derate 24 4mW/°C above +70°C) 1951 2mW	

Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	
Lead Temperature (soldering, 10)s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DC} = V_{USB} = 5V, V_{BAT} = 4V, V_{\overline{EN}} = 0V, R_{SETI} = 2k\Omega, C_{CT} = 0.068\mu F, T_A = -40^{\circ}C$ to +85°C, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$. Note 1)

PARAMETER	CONDITIONS			MIN	TYP	MAX	UNITS
DC OR USB (Note 2)				•			
Input Voltage Range			0		14	V	
Input Operating Range	(Note 3)			4.15		7.00	V
Input Undervoltage Threshold	Input rising, 500	mV hysteresis	(typ)	3.85	4.0	4.15	V
Input Overvoltage Threshold	Input rising, 200	mV hysteresis	(typ)	7.2	7.5	7.8	V
Input Overvoltage Delay	From overvoltag	e event to char	ger disabled		0.25		S
Input Supply Current	I _{BAT} = 0mA, R _{TH}	$_{HM} = 10k\Omega$			750	1200	μΑ
Shutdown Input Current	$V_{\overline{EN}} = 5V, T_A = -$	+25°C			275	435	μΑ
Input to BAT On-Resistance	Input = $3.7V$, V_B	AT = 3.6V			0.5	0.8	Ω
Input to BAT Dropout Voltage	Input falling, 200	mV hysteresis	(typ)	5	55	120	mV
BAT							
BAT Regulation Voltage	I _{BAT} = 0mA		$T_A = +25^{\circ}C$	4.179	4.2	4.221	.,,
			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	4.166	4.2	4.234	V
BAT Restart Fast-Charge Threshold	From BAT regulation voltage			-180	-150	-120	mV
	R _{SETI} = 1.		5k Ω	950	1000	1050	mA
	V _{USB} = 0V	$R_{SETI} = 2k\Omega$		727	750	773	
DC Charging Current		$R_{SETI} = 5k\Omega$		280	300	320	
		Prequal, F	Prequal, $R_{SETI} = 2k\Omega$, $V_{BAT} = 2.5V$		75	90	
		V _{USEL} = 5V		450	475	500	mA
USB Charging Current	$V_{DC} = 0V$	VuseL = 0	VuseL = 0V		95	100	
		Prequal, F	$R_{SETI} = 2k\Omega$, $V_{BAT} = 2.5V$	60	75	90	
Soft-Start Time	Ramp time to fast-charge current				1.2		ms
BAT Prequal Threshold	V _{BAT} rising, 180mV hysteresis (typ)			2.9	3.0	3.1	V
BAT Leakage Current	V _{DC} = V _{USB} = 0V, V _{BAT} = 4.2V				0.001	5	μΑ
SETI							
R _{SETI} Resistance Range	Guaranteed by	charging curre	nt	1.5		5.0	kΩ

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DC} = V_{USB} = 5V, V_{BAT} = 4V, V_{\overline{EN}} = 0V, R_{SETI} = 2k\Omega, C_{CT} = 0.068\mu F, T_{A} = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $T_{A} = +25^{\circ}C$. Note 1)

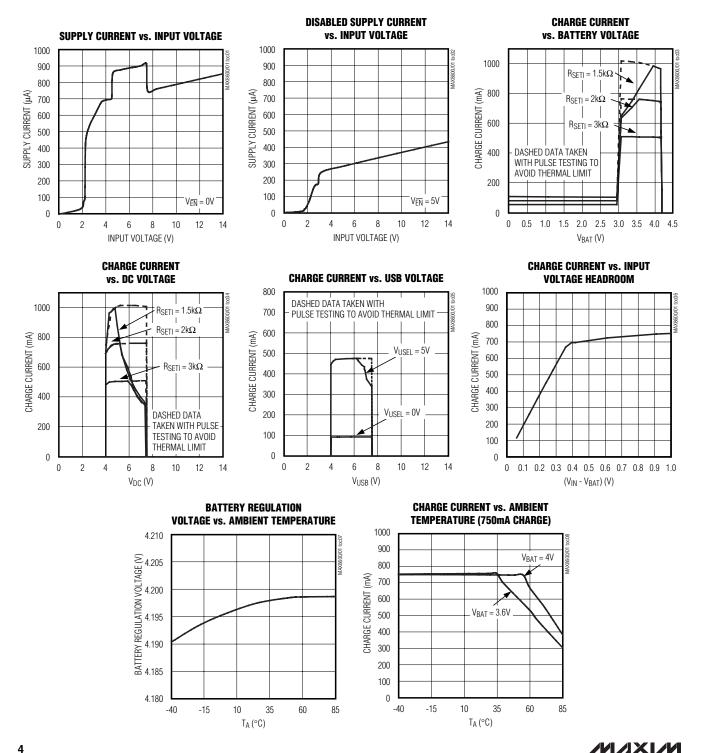
CONDITIONS			TYP	MAX	UNITS	
Rising				1.6	V	
Falling		0.4			V	
V=- Vuosi - 0 to 5 5V	$T_A = +25^{\circ}C$		0.001	1		
VEN = VUSEL = 0 to 5.5V	$T_A = +85^{\circ}C$		0.01		μΑ	
$I_{\overline{POK}}$, = $I_{\overline{CHG}}$ = $I_{\overline{FLT}}$ = 1mA			12	100	mV	
$V_{\overline{POK}} = V_{\overline{CHG}} = V_{\overline{FLT}} = 5.5V,$	$T_A = +25^{\circ}C$		0.001	1		
$V_{DC} = V_{USB} = 0V$	$T_A = +85^{\circ}C$		0.01		μΑ	
IBAT falling, battery is	$R_{SETI} = 1.5 k\Omega$		75		mA	
	$R_{SETI} = 2k\Omega$	37.5	56.25	75.0		
Charged	$R_{SETI} = 5k\Omega$		22.5			
			10		kΩ	
R _{THM} falling, 420Ω hysteresis (typ)			3.94	4.13	kΩ	
R_{THM} rising, $2.7k\Omega$ hysteresis (typ)			28.3	29.7	kΩ	
R_{THM} falling, 230 Ω hysteresis ((typ)	274	309	337	Ω	
$C_{CT} = 0.068 \mu F$		-20		+20	%	
From entering prequal to FLT le	ow, V _{BAT} < 3V		34.8		min	
From entering fast-charge to \overline{F}		334		min		
From CHG high to charger disabled			34.8		min	
Junction temperature when the charge current is reduced, T _J rising			+100		°C	
Reduction of IBAT for increase	of TJ, from VDC, RSETI = 1.5 k Ω		5		%/°C	
	Rising Falling VEN = VUSEL = 0 to 5.5V IPOK, = ICHG = IFLT = 1mA VPOK = VCHG = VFLT = 5.5V, VDC = VUSB = 0V IBAT falling, battery is charged RTHM falling, 420Ω hysteresis RTHM rising, 2.7kΩ hysteresis RTHM falling, 230Ω hysteresis RTHM falling, 230Ω hysteresis RTHM falling, 240Ω hysteresis RTHM falling, 250Ω hysteresis RTHM fall	Rising Falling $V_{\overline{EN}} = V_{USEL} = 0 \text{ to } 5.5V$ $T_{A} = +25^{\circ}C$ $T_{A} = +85^{\circ}C$ $T_{A} = +25^{\circ}C$ $T_{A} = +25^{$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	

- Note 1: Limits are 100% production tested at $T_A = +25$ °C. Limits over the operating temperature range are guaranteed by design and characterization.
- Note 2: Input refers to either DC or USB.
- **Note 3:** Guaranteed by undervoltage- and overvoltage-threshold testing. For complete charging, the input voltage must be greater than 4.32V.



Typical Operating Characteristics

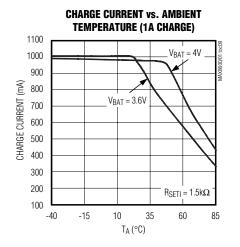
 $(V_{DC} = 5V, R_{SETI} = 2k\Omega, V_{BAT} = 3.6V, MAX8601 evaluation kit with thermal resistance of 50°C/W. T_A = +25°C, unless otherwise noted.)$

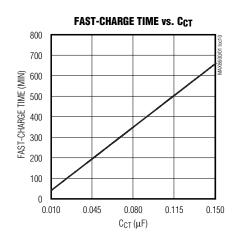


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Typical Operating Characteristics (continued)

 $(V_{DC} = 5V, R_{SETI} = 2k\Omega, V_{BAT} = 3.6V, MAX8601 evaluation kit with thermal resistance of 50°C/W. T_A = +25°C, unless otherwise noted.)$





Pin Description

Р	iN	NAME	FUNCTION		
MAX8600	MAX8601	NAME	FUNCTION		
1	1, 7	ВАТ	Battery Connection. The IC delivers charging current and monitors battery voltage using BA sypass BAT to GND with a 2.2µF or larger ceramic capacitor. Connect both BAT inputs begether externally (MAX8601). BAT is high impedance when the IC is disabled.		
2	2	SETI	DC Charge-Current Programming Input. Connect a resistor from SETI to GND to set the maximum charging current when using the DC input, the prequal current from either input, and the CHG turn-off threshold.		
3	3	THM	Thermistor Input. Connect a $10k\Omega$ NTC thermistor, in close proximity to the battery, from THM to ground to monitor the battery temperature. Connect THM to GND to disable the thermistor functionality. The IC suspends charging when R_{THM} is outside the hot and cold limits.		
4	4	GND	Ground		
5	5	СТ	Timing Capacitor Input. Connect a capacitor from CT to GND to set the precharge timeout, top-off time, and fast-charge timeout. Connect CT to GND to disable the timers.		
6, 7, 9	_	N.C.	No Connection. Make no external circuit connection.		
8	8	ĒN	Active-Low Enable Input. Drive low or connect \overline{EN} to GND to enable the charger. Drive \overline{EN} high to disable the charger.		
10	10	POK	Power-OK Monitor. \overline{POK} is an open-drain output that pulls low when a valid charging source is detected at either DC or USB (MAX8601). \overline{POK} is high impedance when \overline{EN} is high.		
11	11	CHG	Charging-Status Output. $\overline{\text{CHG}}$ goes low when the battery is above 3V and being charged with a current greater than 7.5% of the current programmed with R _{SETI} . $\overline{\text{CHG}}$ is high impedance when the charger is in prequal, top-off, or disabled.		

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Pin Description (continued)

Р	IN	NAME	FUNCTION			
MAX8600	MAX8601	INAIVIE	FUNCTION			
12, 13	12, 13	DC	DC Input Supply. Connect DC to a 4.5V to 7V charging source. Bypass DC to GND with a 1µF or larger capacitor. DC takes priority over USB when both are present (MAX8601). Both DC inputs should be connected together externally.			
14	14	FLT	Fault Status Output. FLT goes low when either the prequal timer or the fast-charge timers expire and the battery voltage is not above the required threshold. Clear the fault by raising EN or removing input power.			
_	9	USB	USB Input Source. Connect to a USB port. Bypass USB to GND with a 1µF or larger capacitor.			
_	6	USEL	USB Charge-Select Input. Logic input that determines the maximum charge current drawn from the USB input. IBAT = 95mA when USEL = low, and IBAT = 475mA when USEL = high.			
_	_	EP	Exposed Pad. Connect to the GND plane for optimum thermal dissipation.			

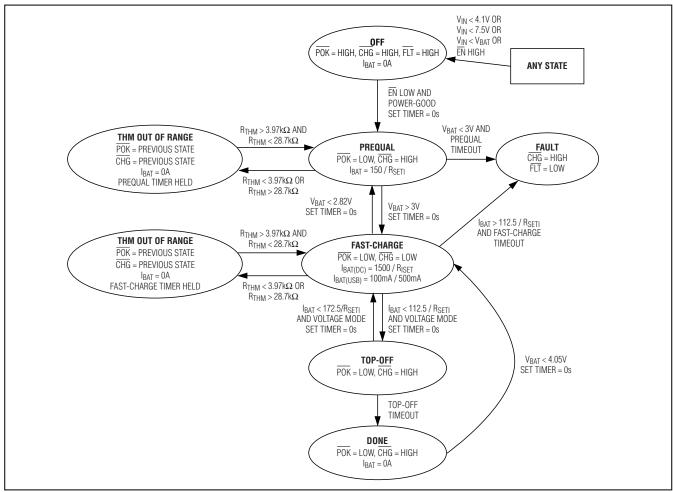


Figure 1. Charger State Diagram

_Detailed Description

DC Charging

The MAX8600/MAX8601 are designed to charge a single-cell Li+ battery from a DC source voltage between 4.15V and 7V. The precharge current, charge current, and top-off threshold are programmable with RSETI.

USB Charging (MAX8601)

The MAX8601 contains a USB input that allows operation from either a DC source or a USB port. A USEL input allows the user to select either a 100mA or 500mA maximum charging current when using the USB input. If both VUSB and VDC are valid, the MAX8601 operates from DC. If VDC is invalid (undervoltage/overvoltage), the MAX8601 operates from USB. When charging at 100mA from the USB input, the fast-charge timer is inhibited.

EN Charger-Enable Input

EN is a logic input (active low) that enables the charger. Drive EN high to disable the charger-control circuitry. Drive EN low or connect to GND for normal operation.

Soft-Start

To prevent input transients, the rate of change of charging current is limited. When the charger is turned on or when the input source is changed, charge current is ramped from 0 to the set current value in typically 1.2ms. This also means that if charging is taking place from USB, and the DC input is then powered, charge current falls to zero and then is reramped to the DC charge rate. This is done to ensure that the DC source is not subjected to a severe load current step.

Charge-current ramp up is also limited when transitioning from prequal to fast-charge, and when changing the USB charge current from 100mA to 500mA with USEL. There is no di/dt limiting, however, if ISET is changed suddenly using a switch at RSETI.

Thermal-Limit Control

The MAX8600/MAX8601 feature a thermal limit that reduces the charge current when the die temperature exceeds +100°C. As the temperature increases above +100°C, the IC lowers the charge current by 5%/°C.

CHG Charge-Indicator Output

 $\overline{\text{CHG}}$ is an open-drain output that indicates charger status. $\overline{\text{CHG}}$ goes low during charge cycles where V_{BAT} is greater than 3V and I_{BAT} is greater than 7.5% of the maximum charge current set by R_{SETI}. When the MAX8600/MAX8601 are used in conjunction with a microprocessor (μP), connect a pullup resistor between $\overline{\text{CHG}}$ and the logic I/O voltage to indicate charge status to the μP. Alternatively, $\overline{\text{CHG}}$ can sink up to 20mA for an LED charge indicator.

Fault Indicator (FLT)

The MAX8600/MAX8601 contain an open-drain FLT output to signal the user when a fault occurs. FLT goes low if the charger is in prequal and the prequal timer expires, or if the charger is in fast-charge and the fast-charge time expires. FLT does NOT go low if the THM thermistor temperature is out of range. Toggle EN or the input power to reset the FLT indicator.

Power-OK Indicator (POK)

The MAX8600/MAX8601 contain an open-drain POK output that goes low when a valid input source is detected at DC or USB (MAX8601 only). A valid input source is one whose voltage is between 4.15V and 7V and exceeds the battery voltage by 320mV. After a valid input has been established, charging is sustained with inputs as low as 3.5V as long as the input voltage remains above the battery voltage by at least 55mV (typ). POK is high impedance when the charger is disabled.

_Applications Information

Figure 2 shows the typical operating circuit for the MAX8601. The following section describes component changes for different charging current and timer durations.

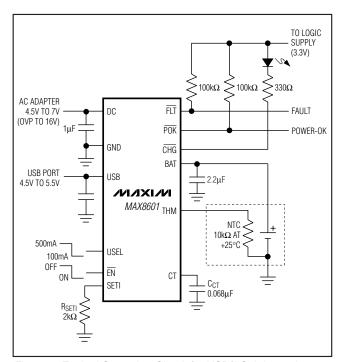


Figure 2. Typical Operating Circuit for USB/AC-Adapter Input Charger. An R_{SETI} of $2k\Omega$ sets an AC adapter fast-charge of 750mA.

Table 1. Fault Temperatures for Different Thermistors

THERMISTOR BETA	3000	3250	3500	3750
Resistance at +25°C	$10,000\Omega$	10,000Ω	$10,000\Omega$	10,000Ω
Resistance at +50°C	4587.78Ω	4299.35 $Ω$	4029.06Ω	3775.75Ω
Resistance at 0°C	$25,140.55\Omega$	$27,148.09\Omega$	$29,315.94\Omega$	$31,656.90\Omega$
Nominal Hot Trip Temperature	+55.14°C	+52.60°C	+50.46°C	+48.63°C
Nominal Cold Trip Temperature	-3.24°C	-1.26°C	+0.46°C	+1.97°C

Charge Current Selection

The maximum charging current from a supply connected to DC is programmed by an external resistor (RSETI) connected from SETI to GND. Calculate the RSETI value as follows:

where I_{CHARGE(MAX)} is in amps and R_{SETI} is in ohms. SETI can also be used to monitor the actual charge-current level. The output voltage at SETI is proportional to the charging current as follows:

Note that the prequal current for both USB and DC input operation is 1/10 of the fast-charge current set by RSETI. Also, the top-off charge-current threshold for both USB and DC input operation is set to 7.5% of the fast-charge current set by RSETI.

Timer Capacitor Selection

The MAX8600/MAX8601 contain timers for prequal, fast-charge, and top-off operation. These time periods are determined by the capacitance from CT to GND. To set the charge times, calculate CCT as follows:

Note that when charging at 100mA from the USB input (MAX8601), the fast-charge timer is inhibited. When THM halts charging, the timers stop and hold their value.

Battery Temperature Control

The MAX8600/MAX8601 monitor battery temperature through a negative TC thermistor which is in close thermal contact with the battery. Select a thermistor resistance that is $10k\Omega$ at $+25^{\circ}$ C and has a beta of 3500. The IC compares the resistance from THM to GND and suspends charging when it is greater than $28.3k\Omega$ or

less than $3.94k\Omega$, which translates to a temperature of 0°C to +50°C. Table 1 shows the nominal temperature limits that result from a wide range of available thermistor temperature curves. The curves are defined by the following equation:

$$R_T = R_{25^{\circ}C \times e} \left\{ \beta \left[\left(\frac{1}{T + 273} \right) - \left(\frac{1}{298} \right) \right] \right\}$$

where β is the BETA term in Table 1.

Connect THM to GND to disable the temperature-control function. When R_{THM} disables charging, all timers pause and hold their value.

Capacitor Selection

Connect a 2.2 μ F ceramic capacitor from BAT to GND for proper stability. Connect a 1 μ F ceramic capacitor from DC to GND. If using the USB input for the MAX8601, bypass USB to GND with a 1 μ F ceramic capacitor. Use a larger input bypass capacitor for high charging currents to reduce supply noise. All capacitors should be X5R dielectric or better. Be aware that some capacitors have large voltage coefficients and should be avoided.

Thermal Considerations

The MAX8600/MAX8601 are in a thermally enhanced TDFN package with an exposed paddle. Connect the exposed paddle of the package to a large copper ground plane to provide a thermal contact between the device and the circuit board. The exposed paddle transfers heat away from the device, allowing the IC to charge the battery with maximum current, while minimizing the increase in die temperature. Note that the MAX8600/MAX8601s' thermal-limit control allows the charger to be tolerant of thermally restricted PC board layouts that are sometimes unavoidable in compact portable designs. With such non-optimal layouts, the charger still operates, but may reduce charge current to manage temperature rise.

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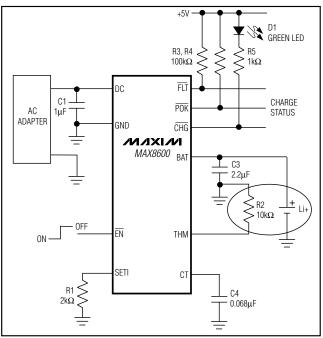


Figure 3. Stand-Alone Li+ Battery-Charger with the MAX8600

DC Input Sources

The MAX8600/MAX8601 operating input voltage range is 4.15V to 7V. The device survives input voltages up to 16V without damage to the IC. If the input voltage is greater than 7.5V (typ), the IC stops charging. An appropriate power supply must provide at least 4.2V plus the voltage drop across the internal pass transistor when sourcing the desired maximum charging current.

where R_{ON} is the input-to-BAT resistance (typically 0.5 Ω). Failure to meet this requirement results in an incomplete charge or increased charge time.

Stand-Alone Li+ Charger

The MAX8600 provides a complete Li+ charging solution. Figure 3 shows the MAX8600 as a stand-alone Li+ battery charger. The $2k\Omega$ resistor connected to SETI sets a charging current of 750mA. The LED indicates when fast-charge has begun. When fast-charge is complete, the LED turns off.

USB-Powered Li+ Charger (MAX8601)

The universal serial bus (USB) provides a high-speed serial communication port as well as power for the

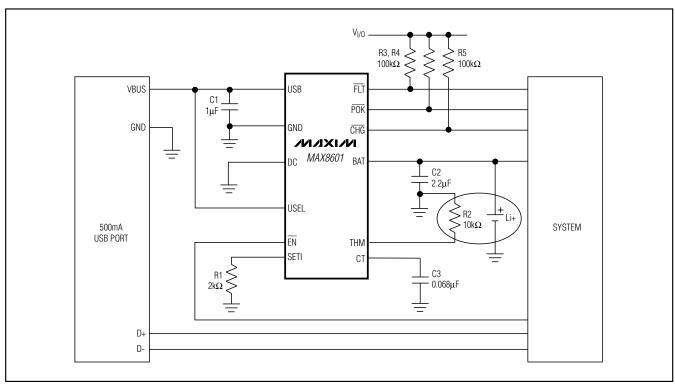


Figure 4. USB Battery Charger with the MAX8601

remote device. The MAX8601 can be configured to charge its battery at the highest current possible from the host port. Figure 4 shows the MAX8601 configured as a USB battery charger. A USEL input sets the maximum charging current from the USB input at 100mA or 500mA.

Layout and Bypassing

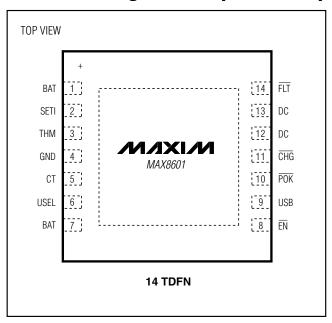
Connect the input capacitors as close to the device as possible. Provide a large copper GND plane to allow the exposed paddle to sink heat away from the device. Connect the battery to BAT as close to the IC as possible to provide accurate battery voltage sensing. Make all high-current traces short and wide to minimize voltage drops. For an example layout, refer to the MAX8601 evaluation kit.

Chip Information

TRANSISTOR COUNT: 6838

PROCESS: BICMOS

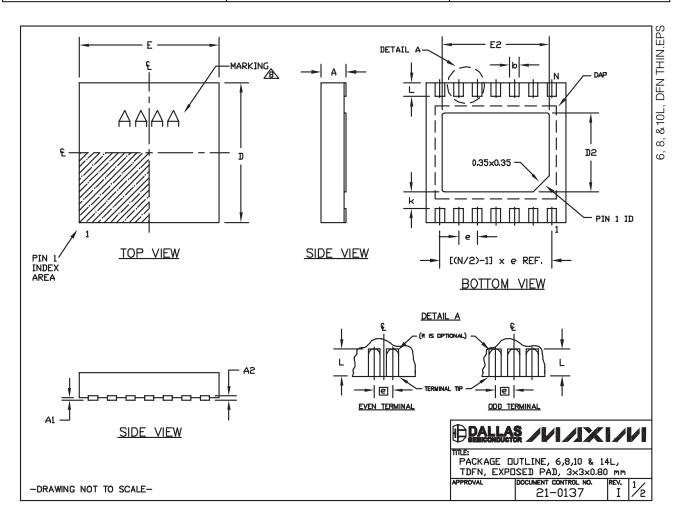
Pin Configurations (continued)



Package Information

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
14 TDFN-EP	T1433-2	<u>21-0137</u>



Package Information (continued)

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.

COMMON DIMENSIONS						
SYMBOL	MIN.	MAX.				
А	0.70	0.80				
D	2.90	3.10				
E	2.90	3.10				
A1	0.00	0.05				
L	0.20	0.40				
k	0.25 MIN.					
A2	0.20 REF.					

PACKAGE VARIATIONS							
PKG. CODE	N	D2	E2	е	JEDEC SPEC	b	[(N/2)-1] x e
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1033-2	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC		0.20±0.05	2.40 REF

- 1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
- 2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
 3. WARPAGE SHALL NOT EXCEED 0.10 mm.
- 4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
- 5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2", AND T1433-1 & T1433-2.
- 6. "N" IS THE TOTAL NUMBER OF LEADS.
- 7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
- ⚠ MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

PACKAGE DUTLINE, 6,8,10 & 14L,

-DRAWING NOT TO SCALE-

TDFN, EXPOSED PAD, 3x3x0.80 mm DOCUMENT CONTROL NO. 21-0137

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
2	7/08	Corrected Absolute Maximum Rating	2
3	12/08	Corrected Absolute Maximum Ratings and made various updates	1, 2, 3, 6, 7

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